













Board Stack Up

Layers:	Thickness(mils):
Top	1.35 (1 oz copper)
Dielectric	9
GND	1.35 (1 oz copper)
Dielectric	38.6
PWR	1.35 (1 oz copper)
Dielectric	9
Bottom	1.35 (1 oz copper)

board material = FR4
 overall board dimensions = 1.7 in * 2.7 in
 solder mask color = green
 silkscreen color = white
 Total Board thickness = 62mils
 Mounting holes are 2-56
 notes:
 Yellow box is outer case size (2000 X 3000 X 1000).
 To enable/disable SIP100 (JUMPER 16):
 - ON = 5V
 - OFF = GND